

# The Third Smart Laser Processing Conference 2018

# SLPC2018

Organized by Japan Laser Processing Society

**APRIL 24 (Tues.) to 26 (Thurs.), 2018**

**Pacifico Yokohama, Yokohama, Japan**

<http://www.jlps.gr.jp/slpc2018/>



Co-located with Optics & Photonics International Congress 2018

## Sponsorship and Advertisement Opportunities

---

**Welcome to join us at SLPC2018!**

Laser beam processing has played an important role in industrial fields, and its technologies are essential to open the new strategies of smart manufacturing process. SLPC2018 deals with science and technology of smart laser materials processing including micro and macro laser processing. SLPC2018 is planned as a three-day event with a plenary session, oral sessions and poster session. The aim of this conference is to provide a forum for discussion of fundamental aspects of laser-matter interaction, the state-of-the-art of smart laser processing, and topics for the next generation with fundamental scientists, end users and laser manufacturers. We expect that SLPC2018 would play an important role not only for understanding fundamental knowledge of laser processing but also forecasting future technologies and the future laser processing fields. During the conference, Optics and Photonics International Exhibition is held jointly near the conference site. We would like to encourage you to become SLPC2018 event sponsor. Please select your sponsorship categories: Advertisements for Abstract Booklets, Platinum, Gold, Silver or Bronze Sponsorships. For the details, please refer to the following pages. Thank you for your attention in advance.

Prof. Masahiro Tsukamoto, Conference Chair, SLPC 2018

## Partnership Categories

Sponsorship:	<b>PLATINUM:</b>	Open for 1 sponsor (GOLD x 2 orders=PLATINUM)
	<b>GOLD:</b>	Open for 5 sponsors (SILVER x 2 orders =GOLD)
	<b>SILVER:</b>	Open for 5 sponsors
	<b>BRONZE:</b>	Open for 10 sponsors

GOLD LEVEL SPONSORSHIP	
<b>Number of Availability</b>	5 sponsors
<b>Contents</b>	<ol style="list-style-type: none"> <li><b>Company Advertisements</b> (one A4 size) will be listed in the abstract booklets to be distributed on site. <b>Company Logo and Name</b> will be shown on the GOLD Sponsorship page of the abstract booklets. (We will provide you one hardcopy of this booklet during/after event.)</li> <li><b>Company Logo</b> will be displayed at the entrance of the conference room.</li> <li><b>Company Logo and Name</b> will be featured in SLPC 2018 website.</li> <li>If you wish, we will link to your company website by clicking the listed company logo. ( URL: <a href="http://www.jlps.gr.jp/slpc2018/">http://www.jlps.gr.jp/slpc2018/</a>)</li> </ol>
<b>Price</b>	¥200,000- per order
<b>Special Arrangements</b>	<ol style="list-style-type: none"> <li>One reception participation fee of SLPC2018 will be waived per one order.</li> <li>With 2 orders, the sponsorship name will be raised up to PLATINUM.</li> <li>After the conference, the participants list will be sent to you. Note: The list includes the information of the participants who had consented the disclosure of their personal information.</li> </ol>
<b>Submission of Ad Materials</b>	Please create your advertisement(s) complying with the guidelines mentioned below, and submit your electric file(s) to us <u>by e-mail</u> and print-out (hardcopy) to us by <u>business mail</u> no later than the due date.
<b>Submission of Company Logo</b>	Please submit us <u>both color and black &amp; white versions</u> of your logo by e-mail.
<b>How to Apply</b>	Please fill out the final page of this file, and fax or e-mail back to us.
<p><b>&lt;Guidelines for Advertisements Specifications&gt;</b></p> <p><b>Size:</b> One A4 sized paper (Height 297mm x Width 210mm)</p> <p><b>Margins:</b> Top/Bottom: Over 20mm, Right/Left : Over 15mm</p> <p><b>Color:</b> <u>Both color and black &amp; white versions</u></p> <p><b>Language:</b> English is preferable.</p> <p><b>File:</b> Fully completed clear one PDF file, please. Do not divide texts and figures separately. File should be possible to open with ADOBE ACROBAT for PDF</p> <p><b>Submission:</b> Please send the PDF file by e-mail at <a href="mailto:slpc218@jlps.gr.jp">slpc218@jlps.gr.jp</a> SLPC 2018 Secretariat, Japan Laser Processing Society Joining and Welding Research Institute, Osaka University 11-1 Mihogaoka, Ibaraki, Osaka 567-0047, Japan</p> <p style="color: red; text-decoration: underline;"><b>Submission Due Date: Jan. 31, 2018</b></p>	

## SILVER LEVEL SPONSORSHIP

<b>Number of availability</b>	<b>5 sponsors</b>
<b>Contents</b>	<ol style="list-style-type: none"> <li><b>1. Company Advertisements</b> (1/2 of A4; Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical) will be listed in the abstract booklets to be distributed on site. And <b>Company Logo and Name</b> will be shown on the SILVER Sponsorship page of this abstract booklets. (We will provide you one hardcopy of this booklet during/after event.)</li> <li><b>2. Company Logo</b> will be displayed at the entrance of the conference room.</li> <li><b>3. Company Logo and Name</b> will be featured in SLPC 2018 website.</li> <li><b>4.</b> If you wish, we will link to your company website by clicking the listed company logo. ( URL: <a href="http://www.jlps.gr.jp/slpc2018/">http://www.jlps.gr.jp/slpc2018/</a> )</li> </ol>
<b>Price</b>	<b>¥100,000- per order</b>
<b>Special Arrangements</b>	<p>After the congress, the participants list will be sent to you.</p> <p>Note: The list includes the information of the participants who had consented the disclosure of their personal information.</p>
<b>Submission of Ad Materials</b>	Please create your advertisement(s) complying with the guidelines mentioned below, and submit your electric file(s) to us <u>by e-mail</u> and print-out (hardcopy) to us by <u>business mail</u> no later than the due date.
<b>Submission of Company Logo</b>	Please submit us <u>both color and black &amp; white versions</u> of your company logo by e-mail.
<b>How to Apply</b>	Please fill out the final page of this file, and fax or e-mail back to us.

### <Guidelines for Advertisements Specifications>

**Size:** Half size of A4 sized paper ( Height 148mm x Width 210mm)

[Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical ]

For 2 orders from one company, you can make one A4 sized ad instead of 2 ads at the half size of A4 sized paper.

**Margins:** Top/Bottom/Right/Left : Over 15mm

Margins for A4 sized ad: Top/Bottom: Over 20mm, Right/Left: over 15mm

**Color:** Both color and black & white versions

**Language:** English is preferable.

**File:** Fully completed clear one PDF file for each ad., please.

Do not divide texts and figures separately.

File should be possible to open with ADOBE ACROBAT for PDF.

**Submission :** Please send the electric file by e-mail.

SLPC2018 Secretariat, Japan Laser Processing Society  
Joining and Welding Research Institute, Osaka University  
11-1 Mihogaoka, Ibaraki, Osaka 567-0047, Japan  
TEL/FAX: +81-6-6879-8642, E-mail: [slpc2018@jlps.gr.jp](mailto:slpc2018@jlps.gr.jp)

**<Ad Submission Due Date> January 31, 2018, JST**

<b>BRONZE SPONSORSHIP</b>	
<b>Number of availability</b>	<b>10 sponsors</b>
<b>Contents</b>	<ol style="list-style-type: none"> <li><b>1. Company Logo and Name</b> will be shown on the BRONZE Sponsorship page of the abstract booklets to be distributed on site.</li> <li><b>2. Company Logo and Name</b> will be featured in SLPC 2018 website.</li> <li><b>3.</b> If you wish, we will link to your company website by clicking the listed company logo. ( URL: <a href="http://www.jlps.gr.jp/lamp/slpc2018/">http://www.jlps.gr.jp/lamp/slpc2018/</a> )</li> </ol>
<b>Price</b>	<b>¥50,000- per order</b>
<b>Special Arrangements</b>	<p>After the congress, the participants list will be sent to you.            Note: The list includes the information of the participants who had consented the disclosure of their personal information.</p>
<b>Submission of Company Logo</b>	Please submit us <u>both color and black &amp; white versions</u> of your logo by e-mail.
<b>How to Apply</b>	Please fill out the final page of this file, and fax or e-mail back to us.
<p>Please e-mail your company logo upon order:            SLPC 2018 Secretariat, Japan Laser Processing Society,            E-mail: <a href="mailto:slpc2018@jlps.gr.jp">slpc2018@jlps.gr.jp</a></p>	

## PAYMENT METHOD FOR SPONSORSHIPS AND ADVERTISEMENTS

**Payment Due Date: January 31, 2018, JST**

[ Bank Account Information for Wire-Transfer to JLPS ]

Bank name: The Bank of Tokyo-Mitsubishi UFJ, Ltd.  
 Branch: Senri Chuo Branch  
 SWIFT Code: BOTKJPJT  
 Bank code: #0005  
 Branch code: #240  
 Account name: "Ittpan Shadan Hojin Laser Kako Gattkai"  
 Account type: Regular ( Futsu )  
 Account Number: 0355276  
 Bank address: 1-4-1, Shinsenri Higashimachi, Toyonaka-shi, Osaka 560-0082,  
 Japan  
 Bank phone #: +81-6-6831-3633

Note: When you make the wire transaction, please make sure to add ¥4000 bank handling charge additionally.

**How to apply** Please fill out the order form shown on the next page, and fax or e-mail back to us.

### **Exhibitions at OPIE**

Please contact OPIE Secretariat for the details.  
 Please visit <http://opicon.jp/exhibition/> for further information

SLPC 2018 PARTNERSHIP ORDER FORM				
<b>Date:</b>	(Month/Date/Year)	Application Number (For LPM office use)		
<b>Company Name</b>	(This is for Listing on Technical Digests and website. Please write your official company name correctly. Do not omit anything such as Co., Ltd.)			
<b>Branch Name</b>				
<b>Department (Your title)</b>				
<b>Person in Charge</b>	(First name, Middle Name(if applicable), LAST NAME)			
<b>Your Address</b>	Street Address			
	City			
	Prefecture/ State			
	TEL	TEL: +Country Code - Area Code - TEL Number		
	FAX	FAX: +Country Code - Area Code - TEL Number		
	E-mail	(Clearly write under-bar, hyphen, etc.)		
<b>Partnership</b>	Items	Price (JPY=Japanese Yen)	Quantity	Sub-Total Amount
	<b>PLATINUM level sponsorship</b>	JPY 400,000-		JPY
	<b>GOLD level sponsorship</b>	JPY 200,000-		JPY
	<b>SILVER level sponsorship</b>	JPY 100,000-		JPY
	<b>BRONZE level sponsorship</b>	JPY 50,000-		JPY
	Sub-Total Amount			JPY
	Bank handling charge for wire-transaction			¥4,000-
	Credit card handling charge (5%) if applicable <input type="checkbox"/> VISA <input type="checkbox"/> MASTER CARD <input type="checkbox"/> NICOS <input type="checkbox"/> UFJ Card Number: _____ Exp. Date: (Month/Year) ____ / ____ Card Holder's Name (Clearly print) _____			Sub-Total Amount x 0.05=  ¥
	<b>TOTAL AMOUNT</b>			<b>¥</b>
	<b>Link to your Company Website</b>	Please circle.            1. Yes, please.            2. No, thank you.		
Your URL	http://			
<b>Advertisement(s) will be posted on</b>	(Month/Date/Year)			
<b>Payment to be made on</b>	(Month/Date/Year)			

- The application will be accepted in order of receipt. Please acknowledge the possibility of sold-out(s) before the application due date. **If you pay by credit card, do not e-mail this form. Please make sure to send it by fax for security reasons.**